

#### **DDR4 DIMM**

TE Internal #: 2199155-3

DIMM Sockets, Double Data Rate (DDR) 4, Board-to-Bus Bar, 288 Position, Surface Mount, Vertical Module Orientation, DDR4 DIMM

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Connectors > Socket Connectors > Memory Sockets > DIMM Sockets > DDR4 DIMM SOCKETS



DRAM Type: Double Data Rate (DDR) 4 Connector System: Board-to-Bus Bar

Number of Positions: 288

Termination Method to Printed Circuit Board: Surface Mount

Module Orientation: Vertical

# All DDR4 DIMM SOCKETS (69)

### **Features**

Product Type Features	
Connector & Contact Terminates To	Printed Circuit Board
DRAM Type	Double Data Rate (DDR) 4
Connector System	Board-to-Bus Bar
Configuration Features	
Number of Positions	288
Module Orientation	Vertical
Body Features	
Ejector Type	Standard
Contact Features	
Contact Current Rating (Max)	.75 A
Termination Features	
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	

**Board Mount** 

.85 mm[.033 in]

Connector Mounting Type

**Housing Features** 

Centerline (Pitch)



#### **Usage Conditions**

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Method	Hard Tray

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

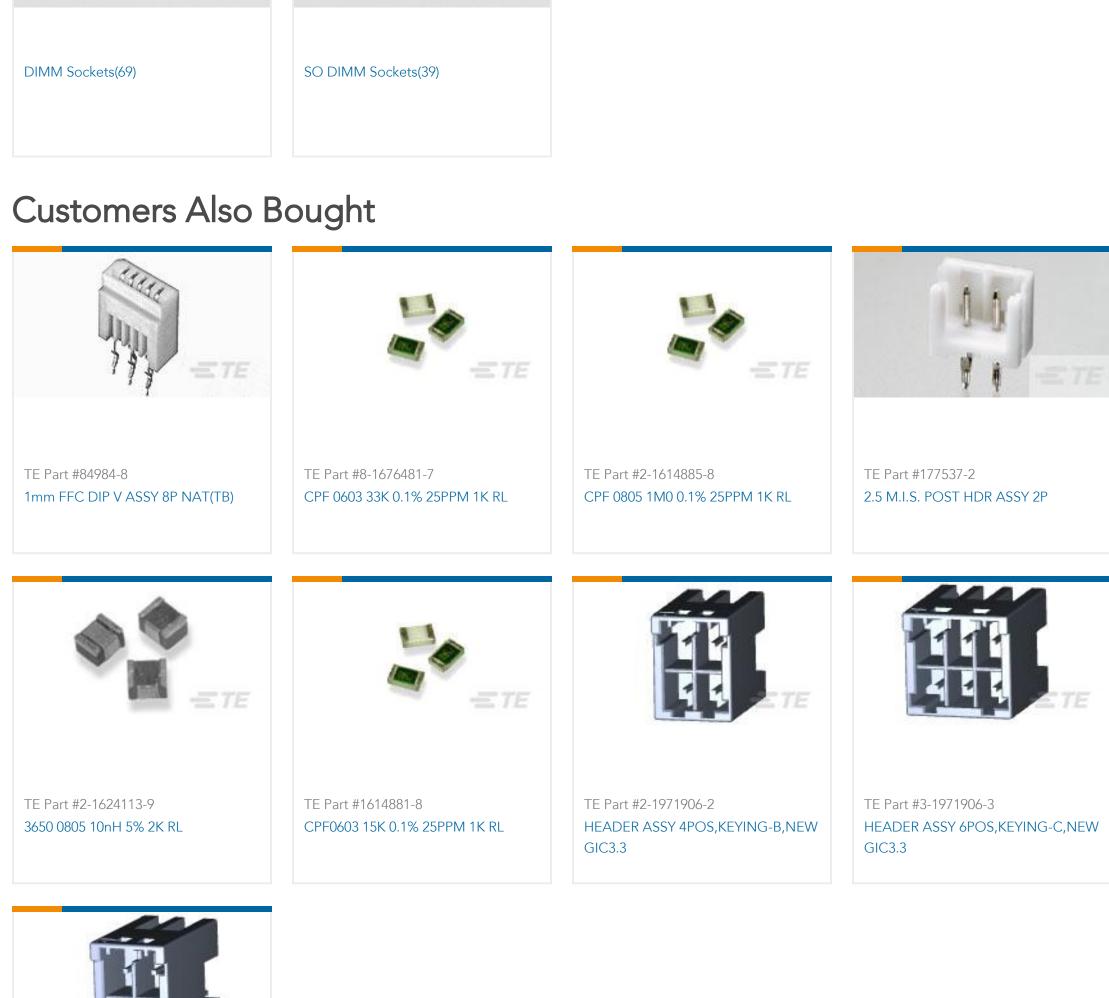
# Compatible Parts





# Also in the Series | DDR4 DIMM









## **Documents**

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2199155-3\_D.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2199155-3\_D.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2199155-3\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

DDR4 DIMM Socket Flyer (English)

English

DDR4 DIMM Socket Flyer (Chinese)

**Product Specifications** 

**Product Specification** 

English